Adaptive Clock with Useful Jitter

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Abstract-The growing variability in nanoelectronic devices due to uncertainties from the manufacturing process and environmental conditions (power supply, temperature, aging) requires increasing design guardbands, forcing circuits to work with conservative clock frequencies. Various schemes for clock generation based on ring oscillators have been proposed with the goal to mitigate the power and performance losses attributable to variability. However, there has been no systematic analysis to quantify the benefits of such schemes. This paper presents and analyzes an Adaptive Clocking scheme with Useful Jitter (ACUJ) that uses variability as an opportunity to reduce power by adapting the clock frequency to the varying environmental conditions and, thus, reducing guardband margins significantly. Power can be reduced between 20% and 40% at iso-performance and performance can be boosted by similar amounts at iso-power. Additionally, energy savings can be translated to substantial advantages in terms of reliability and thermal management. More importantly, the technology can be adopted with minimal modifications to conventional EDA flows.

I. INTRODUCTION

It is widely recognized that the ultimate limit to Moore's law is not technology but economics. Every generation requires an enormous increase in the non-recurring engineering (NRE) and fabrication costs. As a result, the cost per transistor, which had been decreasing at every technology node for several decades, may have been increasing over the last few nodes [1].

Even in the past decade, purely geometrical scaling has been limited by physical challenges and lithography issues. As the supply voltage has stagnated, enhanced performance has been enabled by the notion of *equivalent-scaling* [2] in the International Technology Roadmap for Semiconductors, whereby clever "tricks" have been used to achieve better performance at the next node.

Further, the benefits of scaling are showing diminishing returns. While moving to a new technology node implies a $3-4\times$ increase in manufacturing cost, key metrics such as speed, power, and density are only confined to a 20–20–20% improvement, respectively [3]. The modest progress in performance metrics is largely determined by *variability*: the increasing gap between worst-case and nominal delays that must be covered by conservative guardband margins.

Today's methodologies actively fight off variability. Leading-edge designs use low-variability phase-locked loops (PLLs) for low-jitter clocks and near-zero-skew trees for clock distribution. They employ a strict discipline to maintain the rigidity of timing boundaries, with conservative guardbands used for each combinational block to ensure that these rigid boundaries are not violated. As the magnitude of onchip variability increases, such guardbands incur prohibitive power and delay overheads.

This paper presents a novel design-based equivalent scaling "trick" that embraces dynamic variability instead of fighting it off. The method, based on a new paradigm called *useful jitter*, leverages common-mode variability between the circuit and the clock source and develops an alternative clocking scheme that is an innovative alternative to PLL-based approaches. This clocking scheme, coupled



with a chip-wide design methodology, mitigates the margins required to tolerate dynamic variability, thus reducing the overall chip power.

Unlike the classical goal of attenuating jitter to provide more robust clock generators, the proposed approach *intentionally generates jitter* to accommodate dynamic delay variations. Fig. 1 illustrates the effect of using useful jitter to reduce margins. The waveforms have been obtained with SPICE simulations and show the clock signal arriving at the flip-flops with a power supply fluctuating with $\pm 30\%$ noise. Although this is larger then the voltage droops seen in typical systems, it helps to emphasize the benefits of this technology and could potentially model scenarios in an energy harvesting context.

The PLL (middle) maintains a conservative fixed frequency (810 MHz) to cover the delay variability of the circuit. However, the adaptive clock dynamically adapts the frequency to the variability. By preserving the same nominal voltage (1.2V), it can achieve an average frequency of 1.55 GHz, ranging between 807 MHz and 2.25 GHz. This speed-up can be converted into power savings by scaling voltage. In the bottom waveform we can observe the clock signal working at 0.85V and maintaining an average frequency (814 MHz) similar to one of the PLL working at 1.2V. It is interesting to point out the low frequency of the clock (291 MHz) when power supply approaches V_t (0.28V for NMOS devices). This paper demonstrates how this intentional jitter generates a robust clock without timing violations and provides significant power and performance benefits.

The proposed technology is based on the exploitation of the sensitivity of ring oscillators to PVT variability. Some schemes have been tentatively explored in the past [4]–[6] but no approach with quantifiable benefits has been analyzed. This paper proposes a robust methodology that can be validated by conventional timing sign-off procedures and analyzes its power and performance benefits.

The main features of the Adaptive Clock with Useful Jitter (ACUJ)



can be summarized as follows:

- Efficient: $1.2-1.4 \times$ speed-up or 30%-40% power savings with regard to worst-case sign-off.
- Not invasive: the original circuit is not modified. ACUJ is an alternative to PLLs–both clocks can live together without any need to modify the clock tree.
- **Practical**: adoptable in commercial design flows with conventional sign-off procedures.
- **Reliable:** bringing substantial improvements in thermal management and reliability as a byproduct of power reduction.

II. VARIABILITY, MARGINS AND STATIC TIMING ANALYSIS

We next review the main sources of variability and how margins are taken into account during Static Timing Analysis (STA).

Among the different taxonomies for classifying the sources of variability, we select one that helps to easily identify the margins used for timing sign-off. Table I classifies variability according to two parameters: locality and variation speed.

In terms of locality, global variability affects all devices uniformly whereas local variability has a different impact for each device. Some elements of local variability (e.g., voltage or temperature) may exhibit spatial correlation, i.e., their impact may be similar for devices located in the same region. In terms of variation speed, we can distinguish between static and dynamic variability. Process (P) variability is always static and can be either global (systematic) or local (random). Temperature (T) and aging (A) have slow variability, e.g. of the order of milliseconds or even slower. Both sources have global and local variability components.

Aging will not be discussed in this paper and the analysis will be left for future work. However it is important to point out that ACUJ also brings additional benefits by naturally compensating the aging of the circuit with the aging of the adaptive clock.

Voltage (V) has a diversity of variability components and deserves a special discussion. On the one hand, it has DC components produced by static IR drops that can be either global (off-chip resistance) or local (on-chip power delivery network). On the other hand, voltage variability also has AC components determined by the activity of the system. The largest components of voltage noise have mid and low frequencies and are global [7]. They are produced by the internal activity of the chip that generates high current demands to the voltage regulator and voltage drops across the RLC networks of the board, package and on-chip power delivery.

Timing sign-off must take into account all the possible sources of variability and add margins to cover them. Nowadays, the mechanisms to model variability during STA are the following: (1) *Library corners* to model global variability, (2) *On-Chip Variability* (OCV)



Fig. 3. Launching and capturing paths for timing sign-off.

derating factors to model local variability and (3) *Clock uncertainty* to model jitter and any other safety margin included to account for any uncovered variability or inaccuracy in the analysis.

The two bars shown in Fig. 2 depict a typical delay distribution for timing sign-off. Data has been obtained by simulation of a critical path using SPICE models from a 65nm commercial library. The delays for two cell libraries are reported: Low- V_t (LVT) and High- V_t (HVT). For each library, the delays have been normalized to its typical corner (1.00ns for TT, 1.2V, 25°C; the delays for HVT are about 2× those for LVT) and the contributions of the process (P), voltage (V) and temperature (T) components have been estimated.

Global variability accounts for most of the guardband margins, with P and V being the dominating components. The worst corner covers the worst conditions for PVT global variability (e.g., SS devices, 1.08V, 125° C). Local variability (OCV) also requires a margin modeled as a derating factor that typically ranges between 5% and 15% in conventional sign-off (15% has been chosen in the example). Finally, some fixed margin is usually added for clock uncertainty (0.10ns in the example). Overall, timing sign-off is done at more than 2x the delay of the typical corner.

We next review the base timing analysis to check a setup constraint for a critical path that goes from flip-flop L to flip-flop C (see Fig. 3). Two competing paths are involved: launching (L) and capturing (C). For the circuit to operate correctly, the cycle period (P) must be sufficiently long to meet the setup constraint for all pairs of launching/capturing paths (denoted by set LC):

$$P - J > \max_{i \in IC} (L_i - C_i) \tag{1}$$

where J is the maximum clock jitter. Timing sign-off must guarantee that the clock frequency does not violate any timing constraint under any operating condition. In the presence of variability, margins have to be added to prevent timing failures, as follows.

During STA, global variability is modeled by library corners. Let us assume that we have a set of corners that cover different PVT configurations for devices (fast/typical/slow process, high/typical/low temperature, high/nominal/low voltage) and interconnect (RC_{max} , RC_{min} , ...). Let us call C the set of corners. For every timing path p, we denote by p^c the delay of the path at corner c.

Constraint (1) can now be quantified for all corners and all pairs of paths to derive the minimum cycle period:

$$P - J > \max_{c \in C, i \in LC} (L_i^c - C_i^c) \tag{2}$$

Any clock period P satisfying (2) guarantees a correct behavior for all PVT corners considered for STA.

Local OCV is modeled by applying derating factors to the launching and capturing paths. These factors can be different for each corner. Let us denote δ_L and δ_C the derating factors applied to launching and



Fig. 4. Incorporating ACUJ in a circuit.

capturing paths, respectively. Typically, $\delta_L \ge 1$ and $\delta_C \le 1$. When incorporating local variability, the setup constraint (2) is as follows¹:

$$P - J > \max_{c \in C, i \in LC} (\delta_L L_i^c - \delta_C C_i^c) \tag{3}$$

Next, we describe how this constraint is adapted to the clocking scheme proposed in this paper.

III. ADAPTIVE CLOCK WITH USEFUL JITTER

Fig. 4 depicts ACUJ, the non-invasive clocking scheme proposed in this paper. It is a clock generator with useful jitter that continously adapts to the global variations suffered by the circuit. The clocking scheme includes a clock source implemented as a ring oscillator comprising a delay chain of logic gates that can be physically located at any place within the clock domain and suffer the same global variability as the circuit, as it was shown in Fig. 1. The only required margins must cover the local variations between the ring oscillator and the critical paths in the circuit.

ACUJ can be applied to any clock domain. The frequency of the clock will be continuously fluctuating around a nominal frequency. The frequency at any time instant will be determined by the actual operating conditions at that instant. Each clock domain will have to be isolated with clock-domain crossing (CDC) structures (e.g., asynchronous FIFOs) to prevent synchronization errors with the neighboring domains. This is also a requirement for those schemes that adjust the PLL frequency as a reaction to voltage droop detectors, or for Dynamic Voltage and Frequency Scaling (DVFS) schemes.

A. Timing Model for Adaptive Clock with Useful Jitter

The previous analysis assumes that the period P is obtained from a PLL with a fixed frequency. PLLs are attractive because they can sustain the same frequency even in the presence of variability, and hence they cannot adapt to it. Ring oscillators are often shunned because they supposedly have a large jitter. However, even at the core of a PLL, there is a Voltage Controlled Oscillator (VCO) built with logic gates (e.g. current-starved inverters, to control its frequency). These gates will suffer from the same variation sources as the ring oscillator that we discuss here, but the resulting jitter will be *minimized* rather than *exploited*. Moreover, they will have similar sources of noise, also resulting in unwanted jitter, as the ring oscillator that we use.

Let us now assume that the clock generator is designed as an oscillator using the same type of components as the ones used for the combinational logic and clock trees (e.g., logic gates and buffers). Let us also assume, for the sake of simplicity, that the delays of all components in the circuit scale uniformly with voltage and

¹For simplicity, we assume the same derating factors for all corners.



Fig. 5. Symbolic timing model for Adaptive Clock with Useful Jitter.

temperature². In this case, the period of the clock would naturally adapt to the process corner and operating conditions of the circuit.

Fig. 5 depicts a symbolic representation of the components affected by variability when using ACUJ. The horizontal dimension represents time. The top and bottom paths represent the launching and capturing paths, respectively. The launching path includes the clock tree (shaded) and the critical path delay (white) from flip-flop L to flip-flop C (flip-flops are assumed to have zero delay in this model). The capturing path includes the delay of the ring oscillator (white) and the clock tree (shaded). The paths in the model are equivalent to the ones shown in Fig. 3, explicitly substituting the clock generator by a ring oscillator.

The bullets in the diagram represent signal pulses flying in the launching and capturing paths. In general, the clock tree may contain several flying pulses. Let us assume that the top and bottom bullets are perfectly aligned under the absence of variability and that all components have the same delay d.

Let us call P the time separation (period) between consecutive bullets. With this assumption, an infinite stream of pairs of bullets will arrive synchronized at flip-flop C every P time units.

Let us now assume that voltage drops to a point in which all components are slowed down by a factor s, i.e. every component has delay $s \cdot d$. Then, the time separation between bullets (period) will be increased to $s \cdot P$ but the bullets would still be perfectly aligned in time, i.e. all the bullets will run in slow motion but at the same speed. It is important to notice that the alignment/misalignment of the bullets is independent from the clock tree latency in this model.

If instead a PLL would be used, the period produced by the PLL would not be scaled with voltage and the bullets in the capturing path would be misaligned with regard to the ones flying in the launching path, thus producing setup violations. The only way to avoid the timing violations would be to add margins to the capturing path (reduce the frequency of the PLL) in such a way that the bullets in the capturing path always arrive later.

Hence, the previous model shows how *margins for global variability can be eliminated when using ring oscillators and only margins for local variability are required.* Let us now study how this effect can be formally modeled in terms of STA constraints.

B. Static Timing Analysis of Adaptive Clock with Useful Jitter

By using a ring oscillator, a different cycle period P^c is generated at every corner c. The setup constraint can now hold at every corner c with a different period P^c , i.e.,

$$\forall c \in C, i \in LC: \quad \delta_L L_i^c < \delta_C (P^c + C_i^c) \tag{4}$$

where the term J (jitter) has been removed. The reason is because the fluctuations of the oscillator are accounted as local variability by

 $^{^{2}}$ These assumptions are only made to simplify the conceptual discussion about adaptive clocks and global variability. Any deviation from this assumption, including those due to gate versus wire delays, must be included into the derating factors used in constraints (3) and (4).



Fig. 6. Ring oscillator delay covering PVT variations of critical paths.

applying the derating factor δ_C to P^c . The previous inequality can be rewritten as follows:

$$\forall c: P^{c} > \max_{i \in LC} \left(\frac{\delta_{L} L_{i}^{c}}{\delta_{C}} - C_{i}^{c} \right)$$
(5)

A fundamental difference with (3) is that a different clock period P^c is obtained at every corner. This means that the causes of delay change in the clock generator (ring oscillator) and the circuit are exploited, as long as they are correlated, instead of being minimized in the clock generator (PLL VCO) and taken as margin in the circuit. This allows us to reduce margins substantially as it will be corroborated by the experiments.

C. Implementing a Reliable Adaptive Clock with Useful Jitter

If we compare the top and bottom paths of Fig. 5, we observe the need to match the delay of the ring oscillator with that of the critical path. However, the critical path of the picture is just an abstraction of the multiple critical paths that may determine the clock period under different operating conditions.

In our synthesis framework, we have a path synthesizer that generates a delay that closely matches the delay of the circuit under different operating conditions. The main features of the synthesizer (the details are out of the scope of this paper) are:

- All the PVT corners available for STA are used to calculate the clock period at each corner. OCV derating factors and uncertainty margins are applied to obtain the min value for *P*^c at each corner according to constraint (5).
- The path synthesizer generates a delay that meets all the constraints for P^c . Standard state-of-the-art timing models (e.g. NLDM) and algorithmic techniques are used to solve an optimization combinatorial problem.
- After the synthesis of the ring oscillator, standard STA is used to sign-off at every corner according to (5).

Fig. 6 illustrates the delay constraints for the path synthesizer. The discrete set of points on the horizontal axis represent PVT corners (in increasing order of delay). The lines below the shaded region represent critical path constraints. Each line connects the points of an (L_i, C_i) pair at different corners according to constraint (5). Each pair may have a different sensitivity to PVT variations.

IV. REDUCING MARGINS: PREVIOUS WORK

A. Reducing margins for static variability: parametric binning

Parametric binning [8], either for speed or voltage, is a common technique for reducing margins when worst-case sign-off cannot satisfy certain parameters. In many cases, binning is used to classify dies and assign different prices according to their performance metrics.

Table II summarizes the margins that must be applied to three different scenarios for timing closure: Worst-case sign-off, Parametric Binning and ACUJ. In case of worst-case sign-off, margins must

TABLE II Margins required to cover variability.

	Worst-case sign-off		Parametric Binning		Adaptive Clocks	
	Static	Dyn	Static	Dyn	Static	Dyn
Global	\checkmark	\checkmark		\checkmark		
Local	\checkmark	\checkmark		\checkmark		\checkmark

be used for any kind of variability (global/local, static/dynamic). When doing parametric binning, the margins for static variability can be reduced, since at-speed testing can determine a safe operating frequency. Still, margins for dynamic variability are required because a PLL cannot adapt to the fluctuating operating conditions of the circuit. As we discuss in Section VI, this can improve performance or power by $1.6 \times$ with respect to worst-case sign-off and by $1.2 \times$ even with respect to speed binning under realistic hypotheses.

ACUJ offers additional advantages with regard to binning:

- Margins can also be reduced for global dynamic variability.
- No at-speed testing is required.
- Margins are certified by STA tools and do not depend on the exhaustiveness of at-speed testing vectors.

With ACUJ, every die runs at its *natural speed*, which is determined by its process characteristics and instantaneously adapts to the dynamic operating conditions. There is no need to do binning for a die to run at its natural speed.

Interestingly, ACUJ also improves the speed of dies that fall into the slow/slow process corner. The reason is simple: worst-case corners used in STA assume worst-case VT operating conditions (e.g. 125° C, -10%V), however circuits usually work at more favorable conditions. ACUJ can work at the average frequency determined by the nominal voltage, even though it can tolerate large voltage droops. A similar reasoning could be done for the temperature ranges of the circuit. Circuits driven by PLLs must work at a conservative frequency determined by the worst-case conditions.

B. Reducing margins for dynamic variability

Various techniques have been proposed to mitigate the impact of dynamic variability. One of the most aggressive is Razor [9] and some variants based on a similar concept (e.g., [10]). They reduce the clock period at the expense of tolerating timing errors. The main drawback of Razor-like techniques is the significant area overhead for error detection and correction, which involves intricate schemes to cope with metastability and architectural support for flushing the pipeline and replaying instructions. Along the same lines, Tribeca [11] proposes to use ECC-protected data and local recovery mechanisms to reduce guardband margins and work at nominal conditions.

All the previous techniques can only be applied in advanced microprocessors that incorporate schemes for error detection and recovery. The benefits oscillate around 30-50% power reduction, similar to those of the approach presented in this paper.

The most important dynamic variations are produced by voltage supply droops. Recently, various approaches have been proposed based on techniques for droop detection and adaptive clocking [12]– [15]. Based on the fact that voltage droops last several cycles, droop detectors can be used to anticipate the arrival of the cycles with the largest droop amplitude. All the previously cited techniques propose digital schemes for droop detection based on perceiving differences or timing violations in delay lines or critical path monitors. After detection, different reaction schemes are proposed. One possible reaction is to quickly modify the clock frequency generated by a



Fig. 8. Margins for sign-off in different scenarios.

DLL [12], [14], [15]. Another possibility is to stop the clock during the droop until the voltage is recovered to a stable level [13].

The main limitation of the mechanisms based on droop detection is the reaction latency to modify the clock frequency. Fig. 7 shows a droop that is detected when voltage goes below a certain threshold. Above that threshold, voltage noise must be guardbanded with margins. Once the droop has been detected, some control logic must be activated to modify the clock frequency (DLL reaction time). During that time, voltage continues falling down and margins are also needed to compensate the increasing delays. After that, the margins required to tolerate the maximum droop amplitude can be saved.

Moreover, these schemes do not exploit the fact that short-term voltage variations typically have zero average value over relatively short time intervals (e.g. a few μs), because they are due to second-order inductive effects of the power distribution network. On the other hand, as discussed in Section III-A, *the performance of a circuit driven by ACUJ can be guaranteed over that time interval*. This is essential to ensure functionality of circuits that must satisfy hard external performance constraints.

V. BENEFITS OF ADAPTIVE CLOCKS WITH USEFUL JITTER

The reduction of margins offered by ACUJ results in substantial power and performance benefits that depend on the technology and the application domain. We next give a qualitative estimation of these benefits based on the conventional methodologies used for timing sign-off (the following section provides more quantitative analysis). Fig. 8 (left) shows the margins used in STA for a corner-based sign-off. The horizontal axis represents the $[\mu \dots \mu + 3\sigma]$ range of process variability for a particular distribution of dies³ and the vertical axis represents the cycle period.

The bullets represent the delay obtained at the typical corner (TC) and worst-case corner (WC). Local (on-chip) variability is added as a derating factor applied to the delay determined by the corner.

Finally, a constant margin is added for clock uncertainty (jitter, inaccuracies in the timing models, etc.). The clock period for Worst-Case Sign-off is given by the addition of all the previous margins on the delays determined by the WC corner.

Fig. 8 (right) depicts the margins required for ACUJ and the performance difference with regard to "Speed Binning" and "WC

 3 For simplicity, we focus on the positive segment of the distribution and disregard the negative interval approaching the *best* corner.

Sign-off". The benefits come from the elimination of the margins for dynamic global variability.

A few points have a special interest for analysis. Point **W** represents the cycle period for WC Sign-off. Point **A** represents the cycle period for a die with typical process variation using ACUJ. This point also assumes the systems to be working at a nominal *average voltage* and *temperature*. The difference between **A** and **W** represents the benefits for a typical die when no speed binning is applied.

When comparing ACUJ with WC sign-off, the benefits depend on the process characteristics of each die. For WC sign-off, all dies are specified to run at a unique clock period that is calculated to guarantee a certain yield. ACUJ allows each die to run at its natural speed, which is mostly limited by the process characteristics of the manufactured devices. With regard to the environmental parameters (voltage and temperature) the performance is determined by their average value instead of their worst value.

Point C represents the cycle period achievable by a worst-caseprocess die using ACUJ. The difference between W and C is determined by the global VT variability.

Speed binning can reduce margins for process variability according to the process attributes of each die. An ideal binning procedure would determine the clock frequency by only the margins required for dynamic and local variability. Point **B** represents the achievable performance for a typical die. Again, the difference between **A** and **B** is determined by the global VT variability. It can also be observed that no benefits are obtained between speed binning and WC Sign-off for worst-case dies.

The region between lines **B-W** (Speed Binning) and **A-C** (ACUJ) represents the benefits of adapting to global VT variability.

VI. EXPERIMENTS

The benefits of the scheme presented in this paper have been evaluated in two different scenarios: electrical simulations and an FPGA prototype. The results are consistent and demonstrate significant benefits in terms of performance and power when using ACUJ.

A. Electrical simulations

The experiments were performed with a 65nm low- V_t commercial library and an AES module [16] synthesized with Synopsys' Design Compiler[®]. A programmable ring oscillator was also synthesized using gates from the same cell library. Synopsys PrimeTime[®] was used to generate a SPICE netlist including the top 5 critical paths of the circuit and the ring oscillator. The critical paths were totally disjoint and obtained from different corners. This is a good trade-off between selecting representative timing paths and making the SPICE simulations affordable. The simulations were customized to toggle the inputs of the launching flip-flops at every cycle.

Global voltage variations were modeled by applying sinusoidal fluctuations with different amplitudes at frequencies fully misaligned with the clock frequency, as shown in Fig. 1. No local variability was assumed in this simulation framework.

Table III reports the maximum average frequency achieved without timing violations at each PVT corner. To evaluate the benefits of ACUJ with regard to PLL, different scenarios must be considered. We assume that the chip would work at a nominal voltage with $\pm 10\%$ fluctuations and at an average temperature of 75°C.

• Worst-case sign-off. In this case, the frequency of the PLL (0.89GHz) would be determined by the worst corner (SS, 1.08V, 125°C). The average frequency of ACUJ would depend on the process parameters of the die and the average operating conditions. For a typical die (TT) the frequency would

Process variability \rightarrow Typical (TT) Worst (SS) Voltage Temp PLL ACUJ PLL ACUJ $25^{\circ}C$ 1.59 1.56 1.22 1.211.2V $75^{\circ}C$ 1.46 1.45 1.13 1.13 $125^{\circ}C$ 1.39 1.38 1.07 1.07 $25^{\circ}C$ 1 35 1.55 0.98 1.20 $1.2V \pm 10\%$ $75^{\circ}C$ 1.27 1.45 0.94 1.13 $125^{\circ}C$ 1.19 0.89 1.07 1.37 $25^{\circ}C$ 0.81 1.49 0.55 1.16 $1.2V \pm 30\%$ $75^{\circ}C$ 0.79 1.40 0.53 1.10 $125^{o}C$ 0.78 1.34 0.52 1.05

TABLE III $F_{AVG} \ (GHz) \ \text{for different PVT parameters using PLL and ACUJ}.$

be 1.45GHz. Even in the case of a slow die (SS), the frequency would be 1.13GHz.

• **Speed binning.** The margins for process variations would be mostly reduced for the PLL. Still, the margins for dynamic variability should be kept. For a typical die, the PLL could run at 1.19GHz (-10%, 125°C) whereas ACUJ would run at 1.45GHz.

Therefore, speed-ups ranging from 1.27x to 1.63x are obtained with regard to worst-case sign-off depending on the process parameters (delays between TT and SS). When comparing with speed binning, the speed-ups range from 1.22x to 1.27x.

An important observation is the high robustness to voltage noise, even when the supply changes by $\pm 30\%$. While the PLL has to drastically reduce frequency to tolerate voltage droops (e.g., from 1.39 down to 0.78 for a typical die), ACUJ only needs a very small reduction (from 1.38 down to 1.34). Thus, ACUJ is a resilient solution for systems living in hostile environments with unreliable power supplies, like low-cost regulators or energy scavenging scenarios.

When considering local variability, some derating factors would be applied to both cases, PLL and ACUJ, but the benefits and conclusions would be similar.

B. FPGA prototype

The tolerance to global variability was evaluated using an FPGA (Xilinx Spartan 3E) implementing the same AES module [16] and connected to an oscillating power supply. The clock tree was connected to a multiplexer capable of selecting between a conventional PLL and a ring oscillator constructed by a chain of CLBs (similar to the scheme shown in Fig. 4).

The experiments measured the maximum error-free frequency achievable by the FPGA under different voltages and fluctuations. Given that the experiments were performed on the same die, no process variations were measured. For this reason, these experiments estimated the benefits of ACUJ when compared to a perfect speed binning. The impact of temperature was not considered.

Fig. 9 plots the maximum frequency that was achieved under different amplitudes of voltage noise. The power supply was generated as a low-frequency sinusoidal signal, simulating the effect of an unregulated power supply (higher frequency variations would be cut by the on-chip decoupling capacitors). The noise amplitude ranged from 0% to $\pm 30\%$, i.e., $[0.84V \dots 1.56V]$.

As expected, the PLL frequency had to be reduced to keep the circuit operating correctly. However, ACUJ could sustain an almost constant average frequency across a large range of voltage noise. The speed-up of ACUJ with regard to a PLL was 1.19x, 1.39x and 2.3x for $\pm 10\%$, $\pm 20\%$ and $\pm 30\%$ voltage noise, respectively.

Fig. 10 reports the power benefits for different voltage levels and $\pm 10\%$ voltage noise. The vertical arrows (\downarrow) indicate the power



Fig. 9. FPGA: Voltage Noise vs. Frequency for 1.2V nominal voltage.



Fig. 10. FPGA: Frequency-Power plot for $\pm 10\%$ voltage noise.

savings obtained by voltage scaling at a given average frequency (-23% at 120 MHz and -25% at 100 MHz). The diagonal arrows (\nearrow) connect iso-voltage points and represent the speed-up obtained by simply using ACUJ instead of a PLL without changing voltage.

The results are consistent with the savings estimated by SPICE simulations under the assumption that dies are perfectly binned.

VII. CONCLUSIONS

After the happy-scaling days, it is time to find mechanisms that can maximally exploit the capabilities of technology nodes at nanometric scale. Adaptive Clock with Useful Jitter emerges as an innovative paradigm to handle variability and an alternative to paying the exorbitant costs of guardband margins.

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